

Unconfirmed Meeting Minutes: IEEE P802.3dm Asymmetrical Electrical Automotive Ethernet Task Force Electronic Ad Hoc

June 16, 2026
Electronic Ad Hoc Meeting

Prepared by George Zimmerman

IEEE P802.3dm Ad Hoc meeting convened at **09:33 AM EDT**, Tuesday, June 16, 2026, by Natalie Wienckowski, Chair of the Task Force. **All times are in EDT.**

Attendance is listed in Appendix A.

Presentation: [agenda 3dm 01 061626.pdf](#)

Presenter: Natalie Wienckowski, IVN Solutions/Ethernovia & Bosch (Chair)

The deck agenda_3dm_01_061626.pdf or revisions to it (where noted) are referred to as the “agenda deck” in these minutes.

Approval of Agenda: The Chair asked whether there were any comments, additions, or corrections to the agenda, shown on slide 2 of the agenda deck. There were none. The Chair announced that the agenda was approved. (**09:34 AM**)

The Chair continued review of the agenda deck.

The Chair noted that there should be no recording or photography without permission.

The Chair asked if anyone was attending from the press including those who would run a public blog on this meeting – there were no indications from the group. (**09:37 AM**)

The Chair then continued review of the presentation, reviewing decorum, information for the reflector, private area, and ground rules.

Private Area: The credentials for the private area were not shared as no one needed them.

Attendance: The Chair advised the group that attendance would be taken from the Webex log. The Chair then reminded attendees that they should show their employer & affiliation and instructed how to set these to make them correct. Assistance was offered in case anyone could not rename themselves.

The Chair reviewed the IEEE structure and provided references to bylaws and rules.

IEEE SA Patent Policy: The Chair then reviewed the IEEE SA Patent Policy (slides 13 – 15 of the agenda deck) and made the call for patents. (**09:38 AM**).

There was no response to the call for patents at **09:38 AM**.
The Chair then continued reviewing the agenda deck.

Other IEEE Policies: The Chair reviewed the slides on the IEEE SA copyright, Participant behavior (ethics), IEEE individual participation, fair and equitable consideration policies, decorum, and the IEEE ethics reporting line. (**09:41 AM**). There were no questions.

The Chair reviewed where the group was in the IEEE process, that there were no liaisons or communications, the status of the project documents, and the approved timeline.

The Chair then turned to the proposed presentations for the meeting, on slide 35 of the agenda deck.

PRESENTATIONS

The Chair then moved to the presentations for the meeting. Presentations were related to expected comments against the initial Work Group ballot of P802.3dm.

(9:44 AM)

Title: Screening Attn. Clauses for –V1 191.10.1.5 and 192.8.1.5
URL: https://www.ieee802.org/3/dm/public/adhoc/060226/muma_3dm_01_060226.pdf
Presenter: Bert Bergner (presenter) & Richard Long [TE Connectivity]
Discussion: The presenter discussed a proposal to change the screening attenuation limit in 192.8.1.5 (TDD-V1) to align with 191.10.1.5.

Questions were asked and answered.

(10:13 AM)

Title: Updated Proposal for a 1 Gb/s LS path with 7.5Gb/s or 5Gb/s HS path
URL: https://www.ieee802.org/3/dm/public/adhoc/061626/schedl_et_al_3dm_01_061626.pdf
Presenter: Ahmad Chini [Broadcom] (presenter), Tony Schedl [BMW], Scott Muma [Microchip],
Discussion: The presenter discussed a proposal for comments on the initial Working Group ballot of P802.3dm related to adding a 1 Gb/s low speed path for use with a 5 Gb/s and a 7.5 Gb/s high speed path. He noted that the presentation was an update to the presentation given at the 2 June ad hoc (https://www.ieee802.org/3/dm/public/adhoc/060226/schedl_3dm_01_060226.pdf), changing the additional capacity on the HS path for the 5Gbps/1Gbps mode (slide 5), and reformatting to the figures on slide 7.
The presenter summarized the changes to the technical specifications necessary to implement the proposal.

Questions were asked and answered: In answering questions, the presenter reviewed text changes, previously posted at:
https://www.ieee802.org/3/dm/public/adhoc/060226/chini_3dm_02a_D2d0_1G_comments-preview.pdf, reviewing the capabilities exchange.

(10:49 AM)

FUTURE MEETINGS

Having completed presentations, the Chair reminded the group of scheduled electronic meetings. She announced that the July 7 contingent interim was cancelled, due to increased availability of meeting time during the July 802 plenary.

These are all scheduled from 9:30 AM to 1:30 PM, by Webex, including:

- Out of cycle Interim meetings for D2.0 comment resolution: July 9 (not contingent), July 21 (contingent), and July 23 (contingent).

The Chair also reminded the group that 802.3dm would be meeting during the IEEE 802 plenary in Montreal, Canada during the week of July 13-16, and that a registration fee was required, per IEEE 802 rules. 802.3dm would meet Monday PM, Tuesday PM, Wednesday PM, and Thursday AM of the plenary week.

She announced that the proposed responses to the comments were expected to be uploaded by June 25, and asked participants to inform her if there were specific comments they wished to discuss on July 9.

Having exhausted the agenda, the meeting was adjourned at **10:54 AM** EDT.

Appendix A: Attendees at the IEEE P802.3dm Asymmetrical Electrical Automotive Electronic Ad Hoc Meeting, June 16, 2026

First Name	Last Name	Affiliation
Ramanjit	Ahuja	Onsemi
Bert	Bergner	TE Connectivity
rich	boyer	Aptiv
ahmad	Chini	Broadcom
Shaoan	Dai	Infineon
Daniel	Estrakh	Valens
Steve	Gorshe	Microchip
TJ	Houck	Infineon
Ragnar	Jonsson	Infineon
DoKyun	Kim	LGE
David	Law	HPE
Rich	Long	TE Connectivity
Valerie	Maguire	Copperopolis affl w/ CME Consulting, Microchip, and NXP
Brett	McClellan	Marvell
Yoshihiro	Niihara	Fujikura Ltd.
Alireza	Razavi	Eliyan
Michael	Reinhard	SEI Automotive Europe GmbH
Anton	Schedl	BMW Group
Hossein	Sedarat	Ethernovia
Mehmet	Tazebay	Broadcom
Luisma	Torres	KD
Max	Turner	Ethernovia
Peter	van Dyck	Infineon
Gumersindo	Veloso	BMW
Frank, S.-S.	Wang	Realtek
Natalie	Wienckowski	IVN Solutions; Ethernovia, Bosch
Conrad	Zerna	NXP
George	Zimmerman	CME Consulting/ADI, Cisco, Eliyan, Infineon, OnSemi, Sony